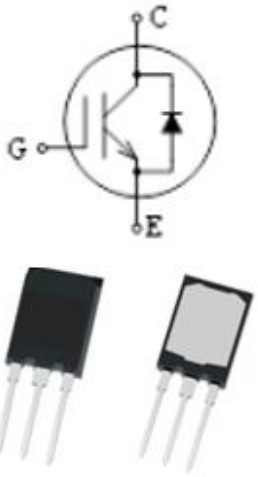
本产品符合 AEC-Q101 标准要求

IGBT in advanced FS Technology with soft and fast recovery anti-parallel diode

具有先进 FS 技术的 IGBT 且反并联软快恢复二极管

Features:
特性



- 1200V planar field-stop technology
  1200V 平面栅场终止技术
- Low switching losses
  低开关损耗
- Positive temperature coefficient
  饱和电压正温度系数
- Short Circuit withstand time-10μs
  具备10μs短路承受能力

Applications:
应用

- Electric Automotive Air-Condition Compressor
  电动汽车空调压缩机

Type 型号	V_{CE}[V] 集电极-发射极电压	I_C[A] 集电极电流	V_{CEsat}[V] 饱和电压	T_{jmax}[°C] 最高结温	Marking 标记	Package 封装
BGM50Q120SD	1200	50	2.5	175	50Q120SD	TO247Plus

Maximum Rated Values
最大额定参数

Parameter 参数	Symbol 符号	Value 值	Unit 单位
Collector-emitter voltage, T_j≥25℃ 集电极-发射极电压,T_j≥25℃	V_{CE}	1200	V
Collector current,T_C=25℃ 集电极电流，Tc=25℃	I_C	100	A
Collector current,T_C=100℃ 集电极电流，Tc=100℃	I_C	50	
Pulsed collector current，t_p limited by $T_{j\,max}$ 集电极脉冲电流，脉宽时间受 $T_{j\,max}$ 限制	I_{Cpuls}	200	
Diode forward current,T_C=25℃ 二极管正向电流，Tc=25℃	I_F	100	
Diode forward current,T_C=100℃ 二极管正向电流，Tc=100℃	I_F	50	
Diode pulsed current 二极管脉冲电流	I_{Fpuls}	200	
Gate-emitter voltage 栅极-发射极电压	V_{GE}	±20	V
Short Circuit withstand time V_{GE}=15V,V_{CC}≤800V,T_j≤150℃ 短路耐受时间	t_{sc}	10	us
Total power dissipation, T_C=25℃ 总耗散功率，Tc=25℃	P_{tot}	652	W
Operating junction temperature 最高结温	T_{jmax}	175	℃
Operating junction temperature 工作结温	T_{jop}	-40…+150	
Storage temperature 储存温度	T_{stg}	-55…+150	
Soldering temperature,1.6mm from case for 10s 焊接温度	T_{st}	300	

Thermal Resistance
热阻

Parameter 参数	Symbol 符号	Value 值	Unit 单位
IGBT Thermal resistance junction to case IGBT 结-管壳热阻	$R_{th(j-c)}$	0.23	°C/W
Diode Thermal resistance junction to case 二极管结-管壳热阻	$R_{th(j-c)}$	0.35	°C/W
Thermal resistance junction to ambient 结-环境热阻	$R_{th(j-a)}$	40	°C/W

Electrical Characteristic at Tj = 25°C （unless otherwise specified）
Tj=25°C时电学特性（除非特别声明）

Parameter 参数	Symbol 符号	Conditions 条件		Value 值			Unit 单位
				Min. 最小值	Typ. 典型值	Max. 最大值	
Static Characteristic **静态特性**							
Collector-emitter breakdown voltage 集电极-发射极击穿电压	$V_{(BR)CES}$	V_{GE}=0V, I_C=1mA		1200	-	-	V
Collector-emitter saturation voltage 集电极-发射极饱和电压	Vcesat	V_{GE}=15V, I_C=50A	T_j=25°C	-	2.5	2.8	
Diode forward voltage 二极管正向电压	VF	V_{GE}=0V, I_F=50A	T_j=25°C	-	2.5	2.9	
Gate-emitter threshold voltage 栅极-发射极阈值电压	$V_{GE(th)}$	I_C=3mA, V_{CE}=V_{GE}		5.0	5.8	7.0	
Collector-emitter cut-off current 集电极-发射极截止电流	I_{CES}	V_{CE}=1200V, V_{GE}=0V		-	-	100	μA
Gate-emitter leakage current 栅极-发射极漏电流	I_{GES}	V_{CE}=0V, V_{GE}=±20V		-200	-	200	nA
Dynamic Characteristic **动态特性**							
Gate charge 门极电量	Q_G	V_{CC}=600V,I_C=50A, V_{GE}=15V		-	230	-	nC
Short circuit current 短路电流	$I_{C(sc)}$	V_{CC}=800V,V_{GE}=15V, T_j=150°C		-	200	-	A
Reverse bias safe operating area 反偏安全工作区	RBSOA	V_{CC}=800V,V_{GE}=20V, T_j=150°C		100	-	-	

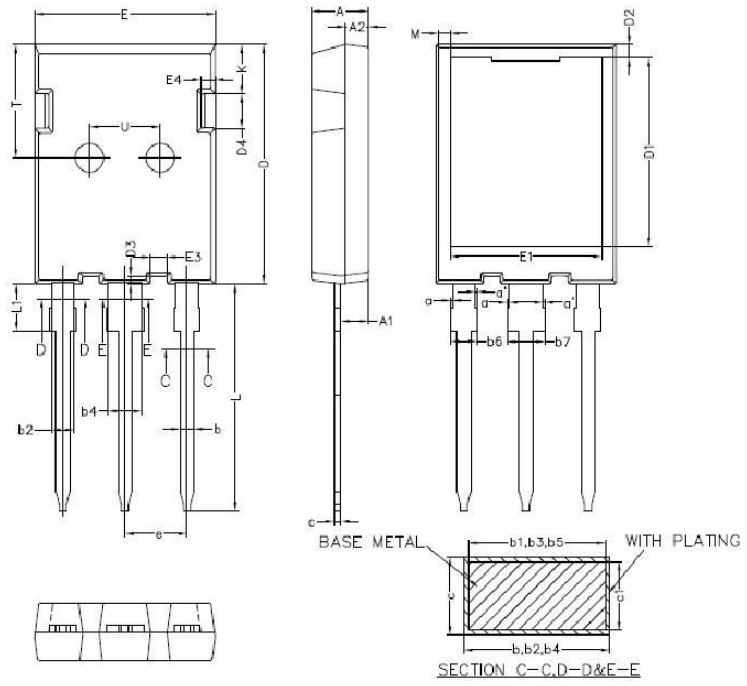
Switching Characteristic at T_j=25℃（Inductive Load）
T_j=25℃时开关特性（感性负载）

Parameter 参数	Symbol 符号	Conditions 条件	Value 值			Unit 单位
			Min. 最小值	Typ. 典型值	Max. 最大值	
IGBT Characteristic **IGBT 特性**						
Turn-on delay time 开通延迟时间	$t_{d(on)}$	T_j=25℃, V_{CC}=600V, I_C=50A, V_{GE}=-7.5/15V, R_G=10Ω, Energy losses include "tail" and diode reverse recovery.	-	76	-	ns
Rise time 上升时间	t_r		-	29	-	
Turn-off delay time 关断延迟时间	$t_{d(off)}$		-	300	-	
Fall time 下降时间	t_f		-	73	-	
Turn-on energy 开通损耗	E_{on}		-	2.3	-	mJ
Turn-off energy 关断损耗	E_{off}		-	2.8	-	
Total switching energy 总开关损耗	E_{ts}		-	5.1	-	
Anti-Parallel Diode Characteristic **反并联二极管特性**						
Reverse recovery time 反向恢复时间	t_{rr}	T_j=25℃, V_R=600V, I_F=50A, diF/dt=380A/μs	-	500	-	ns
Recovered charge 恢复电荷	Q_r		-	2.5	-	μC
Peak reverse recovery current 反向恢复峰值电流	I_{RM}		-	22	-	A
Reverse recovered energy 反向恢复损耗	E_{rec}		-	1.0	-	mJ

Switching Characteristic at T_j=150℃（Inductive Load）
T_j=150℃时开关特性（感性负载）

Parameter 参数	Symbol 符号	Conditions 条件	Value 值			Unit 单位
			Min. 最小值	Typ. 典型值	Max. 最大值	
IGBT Characteristic **IGBT 特性**						
Turn-on delay time 开通延迟时间	$t_{d(on)}$	T_j=150℃, V_{CC}=600V, I_C=50A, V_{GE}=-7.5/15V, R_G=10Ω, Energy losses include "tail" and diode reverse recovery.	-	78	-	ns
Rise time 上升时间	t_r		-	35	-	
Turn-off delay time 关断延迟时间	$t_{d(off)}$		-	406	-	
Fall time 下降时间	t_f		-	169	-	
Turn-on energy 开通损耗	E_{on}		-	4.7	-	mJ
Turn-off energy 关断损耗	E_{off}		-	5.2	-	
Total switching energy 总开关损耗	E_{ts}		-	9.9	-	
Anti-Parallel Diode Characteristic **反并联二极管特性**						
Reverse recovery time 反向恢复时间	t_{rr}	T_j=150℃, V_R=600V, I_F=50A, diF/dt=900A/μs	-	726	-	ns
Recovered charge 恢复电荷	Q_r		-	6.5	-	μC
Peak reverse recovery current 反向恢复峰值电流	I_{RM}		-	29	-	A
Reverse recovered energy 反向恢复损耗	E_{rec}		-	1.96	-	mJ

TO247Pl
us Outline Dimensions:
TO247Plus 外形尺寸



Common Dimensions (Units:Millimeter)			
Symbol	Min.	Nom.	Max.
A	4.90	5.00	5.10
A1	2.31	2.41	2.51
A2	1.90	2.00	2.10
a	0.00	-	0.15
a'	0.00	-	0.15
b	1.16	-	1.26
b1	1.15	1.20	1.22
b2	1.96	-	2.06
b3	1.95	2.00	2.02
b4	2.96	-	3.06
b5	2.95	3.00	3.02
b6	-	-	2.25
b7	-	-	3.25
c	0.59	-	0.66
c1	0.58	0.60	0.62
D	20.90	21.00	21.10
D1	16.25	16.55	16.85
D2	1.05	1.17	1.35
D3	0.58	0.68	0.78
D4	2.90	3.00	3.10
E	15.70	15.80	15.90
E1	13.10	13.26	13.50
E3	1.35	1.45	1.55
E4	1.14	1.24	1.34
e	5.34	5.44	5.54
K	4.25	4.35	4.45
L	19.80	19.92	20.10
L1	3.90	-	4.30
M	0.70	-	1.30
P	2.40	2.50	2.60
R1	0.30REF		
T	9.80	-	10.20
U	6.00	-	6.40
V	35°	-	45°

Packing
包装

Packing	pcs/tube	tube/ inner box	inner box/ carton	pcs/carton
Tube	30	12	6	2160

RESTRICTIONS ON PRODUCT USE

- The information contained herein is subject to change without notice.

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